

## Analog Multiplexers/Demultiplexers

The MC14051B, MC14052B, and MC14053B analog multiplexers are digitally-controlled analog switches. The MC14051B effectively implements an SP8T solid state switch, the MC14052B a DP4T, and the MC14053B a Triple SPDT. All three devices feature low ON impedance and very low OFF leakage current. Control of analog signals up to the complete supply voltage range can be achieved.

- Triple Diode Protection on Control Inputs
- Switch Function is Break Before Make
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Analog Voltage Range ( $V_{DD} - V_{EE}$ ) = 3.0 to 18 V  
Note:  $V_{EE}$  must be  $\leq V_{SS}$
- Linearized Transfer Characteristics
- Low-noise – 12 nV/ $\sqrt{\text{Cycle}}$ ,  $f \geq 1.0 \text{ kHz}$  Typical
- Pin-for-Pin Replacement for CD4051, CD4052, and CD4053
- For 4PDT Switch, See MC14551B
- For Lower  $R_{ON}$ , Use the HC4051, HC4052, or HC4053 High-Speed CMOS Devices

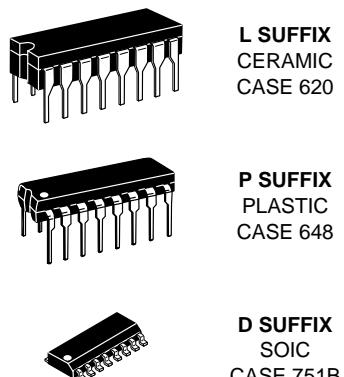
### MAXIMUM RATINGS\*

Symbol	Parameter	Value	Unit
$V_{DD}$	DC Supply Voltage (Referenced to $V_{EE}$ , $V_{SS} \geq V_{EE}$ )	– 0.5 to + 18.0	V
$V_{in}, V_{out}$	Input or Output Voltage (DC or Transient) (Referenced to $V_{SS}$ for Control Inputs and $V_{EE}$ for Switch I/O)	– 0.5 to $V_{DD} + 0.5$	V
$I_{in}$	Input Current (DC or Transient), per Control Pin	$\pm 10$	mA
$I_{sw}$	Switch Through Current	$\pm 25$	mA
$P_D$	Power Dissipation, per Package†	500	mW
$T_{stg}$	Storage Temperature	– 65 to + 150	°C
$T_L$	Lead Temperature (8-Second Soldering)	260	°C

\* Maximum Ratings are those values beyond which damage to the device may occur.

† Temperature Derating: "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C  
Ceramic "L" Packages: – 12 mW/°C From 100°C To 125°C

## MC14051B MC14052B MC14053B

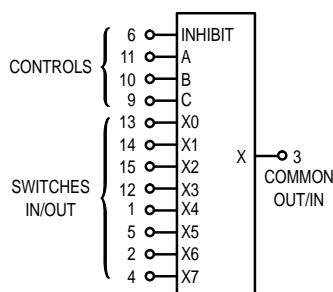


### ORDERING INFORMATION

MC14XXXBCP	Plastic
MC14XXXBCL	Ceramic
MC14XXXBD	SOIC

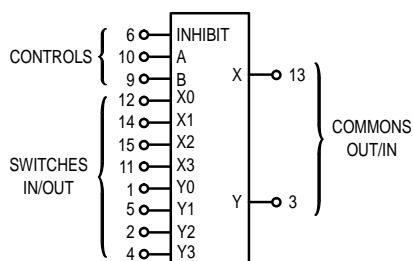
$T_A = -55^\circ$  to  $125^\circ\text{C}$  for all packages.

**MC14051B**  
8-Channel Analog  
Multiplexer/Demultiplexer



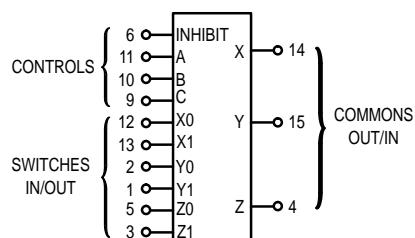
$V_{DD} = \text{PIN } 16$   
 $V_{SS} = \text{PIN } 8$   
 $V_{EE} = \text{PIN } 7$

**MC14052B**  
Dual 4-Channel Analog  
Multiplexer/Demultiplexer



$V_{DD} = \text{PIN } 16$   
 $V_{SS} = \text{PIN } 8$   
 $V_{EE} = \text{PIN } 7$

**MC14053B**  
Triple 2-Channel Analog  
Multiplexer/Demultiplexer



$V_{DD} = \text{PIN } 16$   
 $V_{SS} = \text{PIN } 8$   
 $V_{EE} = \text{PIN } 7$

Note: Control Inputs referenced to  $V_{SS}$ . Analog Inputs and Outputs reference to  $V_{EE}$ .  $V_{EE}$  must be  $\leq V_{SS}$ .

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	V <sub>DD</sub>	Test Conditions	−55°C		25°C			125°C		Unit
				Min	Max	Min	Typ #	Max	Min	Max	

### SUPPLY REQUIREMENTS (Voltages Referenced to V<sub>EE</sub>)

Power Supply Voltage Range	V <sub>DD</sub>	—	V <sub>DD</sub> − 3.0 ≥ V <sub>SS</sub> ≥ V <sub>EE</sub>	3.0	18	3.0	—	18	3.0	18	V
Quiescent Current Per Package	I <sub>DD</sub>	5.0 10 15	Control Inputs: V <sub>in</sub> = V <sub>SS</sub> or V <sub>DD</sub> , Switch I/O: V <sub>EE</sub> ≤ V <sub>I/O</sub> ≤ V <sub>DD</sub> , and ΔV <sub>switch</sub> ≤ 500 mV**	— — —	5.0 10 20	— — —	0.005 0.010 0.015	5.0 10 20	— — —	150 300 600	μA
Total Supply Current (Dynamic Plus Quiescent, Per Package)	I <sub>D(AV)</sub>	5.0 10 15	T <sub>A</sub> = 25°C only (The channel component, (V <sub>in</sub> − V <sub>out</sub> )/R <sub>on</sub> , is not included.)	Typical			(0.07 μA/kHz) f + I <sub>DD</sub> (0.20 μA/kHz) f + I <sub>DD</sub> (0.36 μA/kHz) f + I <sub>DD</sub>			μA	

### CONTROL INPUTS — INHIBIT, A, B, C (Voltages Referenced to V<sub>SS</sub>)

Low-Level Input Voltage	V <sub>IL</sub>	5.0 10 15	R <sub>on</sub> = per spec, I <sub>off</sub> = per spec	— — —	1.5 3.0 4.0	— — —	2.25 4.50 6.75	1.5 3.0 4.0	— — —	1.5 3.0 4.0	V
High-Level Input Voltage	V <sub>IH</sub>	5.0 10 15	R <sub>on</sub> = per spec, I <sub>off</sub> = per spec	3.5 7.0 11	— — —	3.5 7.0 11	2.75 5.50 8.25	— — —	3.5 7.0 11	— — —	V
Input Leakage Current	I <sub>in</sub>	15	V <sub>in</sub> = 0 or V <sub>DD</sub>	—	± 0.1	—	± 0.00001	± 0.1	—	1.0	μA
Input Capacitance	C <sub>in</sub>	—		—	—	—	5.0	7.5	—	—	pF

### SWITCHES IN/OUT AND COMMONS OUT/IN — X, Y, Z (Voltages Referenced to V<sub>EE</sub>)

Recommended Peak-to-Peak Voltage Into or Out of the Switch	V <sub>I/O</sub>	—	Channel On or Off	0	V <sub>DD</sub>	0	—	V <sub>DD</sub>	0	V <sub>DD</sub>	V <sub>PP</sub>
Recommended Static or Dynamic Voltage Across the Switch** (Figure 5)	ΔV <sub>switch</sub>	—	Channel On	0	600	0	—	600	0	300	mV
Output Offset Voltage	V <sub>OO</sub>	—	V <sub>in</sub> = 0 V, No Load	—	—	—	10	—	—	—	μV
ON Resistance	R <sub>on</sub>	5.0 10 15	ΔV <sub>switch</sub> ≤ 500 mV**, V <sub>in</sub> = V <sub>IL</sub> or V <sub>IH</sub> (Control), and V <sub>in</sub> = 0 to V <sub>DD</sub> (Switch)	— — —	800 400 220	— — —	250 120 80	1050 500 280	— — —	1200 520 300	Ω
ΔON Resistance Between Any Two Channels in the Same Package	ΔR <sub>on</sub>	5.0 10 15		— — —	70 50 45	— — —	25 10 10	70 50 45	— — —	135 95 65	Ω
Off-Channel Leakage Current (Figure 10)	I <sub>off</sub>	15	V <sub>in</sub> = V <sub>IL</sub> or V <sub>IH</sub> (Control) Channel to Channel or Any One Channel	—	± 100	—	± 0.05	± 100	—	± 1000	nA
Capacitance, Switch I/O	C <sub>I/O</sub>	—	Inhibit = V <sub>DD</sub>	—	—	—	10	—	—	—	pF
Capacitance, Common O/I	C <sub>O/I</sub>	—	Inhibit = V <sub>DD</sub> (MC14051B) (MC14052B) (MC14053B)	— — —	— — —	— — —	60 32 17	— — —	— — —	— — —	pF
Capacitance, Feedthrough (Channel Off)	C <sub>I/O</sub>	— —	Pins Not Adjacent Pins Adjacent	— —	— —	— —	0.15 0.47	— —	— —	— —	pF

#Data labeled "Typ" is not to be used for design purposes, but is intended as an indication of the IC's potential performance.

\* For voltage drops across the switch ( $\Delta V_{switch}$ ) > 600 mV (> 300 mV at high temperature), excessive V<sub>DD</sub> current may be drawn, i.e. the current out of the switch may contain both V<sub>DD</sub> and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded. (See first page of this data sheet.)

**ELECTRICAL CHARACTERISTICS\*** ( $C_L = 50 \text{ pF}$ ,  $T_A = 25^\circ\text{C}$ ) ( $V_{EE} \leq V_{SS}$  unless otherwise indicated)

Characteristic	Symbol	$V_{DD} - V_{EE}$ Vdc	Typ # All Types	Max	Unit
Propagation Delay Times (Figure 6) Switch Input to Switch Output ( $R_L = 10 \text{ k}\Omega$ ) MC14051	tPLH, tPHL				ns
$t_{PLH}, t_{PHL} = (0.17 \text{ ns/pF}) C_L + 26.5 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.08 \text{ ns/pF}) C_L + 11 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.06 \text{ ns/pF}) C_L + 9.0 \text{ ns}$		5.0 10 15	35 15 12	90 40 30	
MC14052		5.0 10 15	30 12 10	75 30 25	ns
MC14053		5.0 10 15	25 8.0 6.0	65 20 15	ns
Inhibit to Output ( $R_L = 10 \text{ k}\Omega$ , $V_{EE} = V_{SS}$ ) Output "1" or "0" to High Impedance, or High Impedance to "1" or "0" Level MC14051B	tPHZ, tPLZ, tPZH, tPZL				ns
		5.0 10 15	350 170 140	700 340 280	
MC14052B		5.0 10 15	300 155 125	600 310 250	ns
MC14053B		5.0 10 15	275 140 110	550 280 220	ns
Control Input to Output ( $R_L = 10 \text{ k}\Omega$ , $V_{EE} = V_{SS}$ ) MC14051B	tPLH, tPHL				ns
		5.0 10 15	360 160 120	720 320 240	
MC14052B		5.0 10 15	325 130 90	650 260 180	ns
MC14053B		5.0 10 15	300 120 80	600 240 160	ns
Second Harmonic Distortion ( $R_L = 10\text{K}\Omega$ , $f = 1 \text{ kHz}$ ) $V_{in} = 5 \text{ Vpp}$	—	10	0.07	—	%
Bandwidth (Figure 7) ( $R_L = 1 \text{ k}\Omega$ , $V_{in} = 1/2 (V_{DD} - V_{EE})$ p-p, $C_L = 50\text{pF}$ $20 \log (V_{out}/V_{in}) = -3 \text{ dB}$ )	BW	10	17	—	MHz
Off Channel Feedthrough Attenuation (Figure 7) $R_L = 1\text{K}\Omega$ , $V_{in} = 1/2 (V_{DD} - V_{EE})$ p-p $f_{in} = 4.5 \text{ MHz}$ — MC14051B $f_{in} = 30 \text{ MHz}$ — MC14052B $f_{in} = 55 \text{ MHz}$ — MC14053B	—	10	-50	—	dB
Channel Separation (Figure 8) ( $R_L = 1 \text{ k}\Omega$ , $V_{in} = 1/2 (V_{DD} - V_{EE})$ p-p, $f_{in} = 3.0 \text{ MHz}$ )	—	10	-50	—	dB
Crosstalk, Control Input to Common O/I (Figure 9) ( $R_1 = 1 \text{ k}\Omega$ , $R_L = 10 \text{ k}\Omega$ Control $t_{TLH} = t_{THL} = 20 \text{ ns}$ , Inhibit = $V_{SS}$ )	—	10	75	—	mV

\* The formulas given are for the typical characteristics only at  $25^\circ\text{C}$ .

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$ ,  $V_{EE}$ , or  $V_{DD}$ ). Unused outputs must be left open.

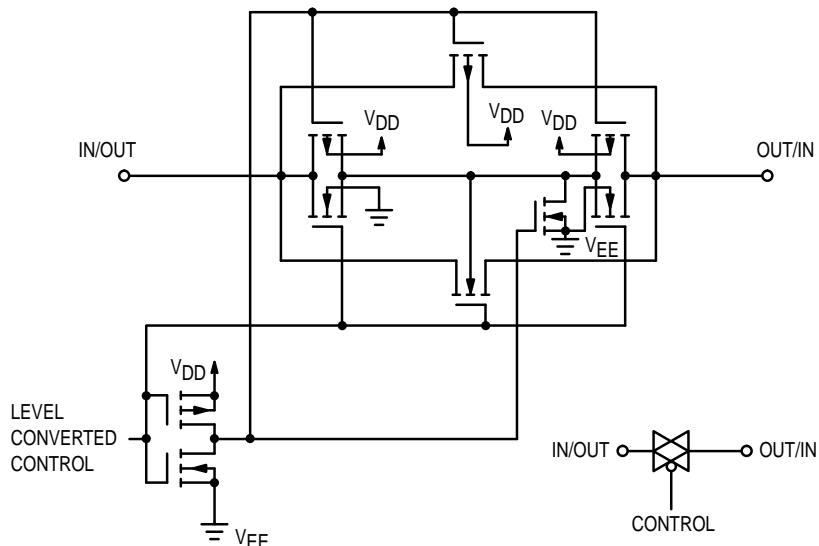


Figure 1. Switch Circuit Schematic

TRUTH TABLE

Control Inputs			ON Switches					
Inhibit	Select		MC14051B		MC14052B		MC14053B	
	C*	B A	X0	Y0 X0	Z0 Y0 X0	X1	Y1 X1	Z0 Y0 X1
0	0	0 0	X0	Y0 X0	Z0 Y0 X0	X1	Y1 X1	Z0 Y0 X1
0	0	0 1	X2	Y2 X2	Z0 Y1 X0	X3	Y3 X3	Z0 Y1 X1
0	0	1 0	X4		Z1 Y0 X0	X5		Z1 Y0 X1
0	0	1 1	X6		Z1 Y1 X0	X7		Z1 Y1 X1
1	x	x x	None	None	None			

\* Not applicable for MC14052

x = Don't Care

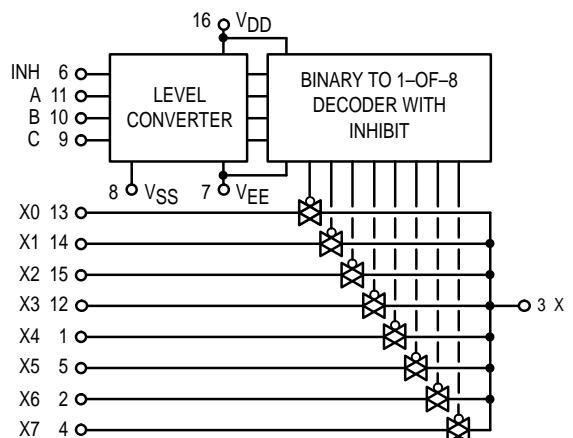


Figure 2. MC14051B Functional Diagram

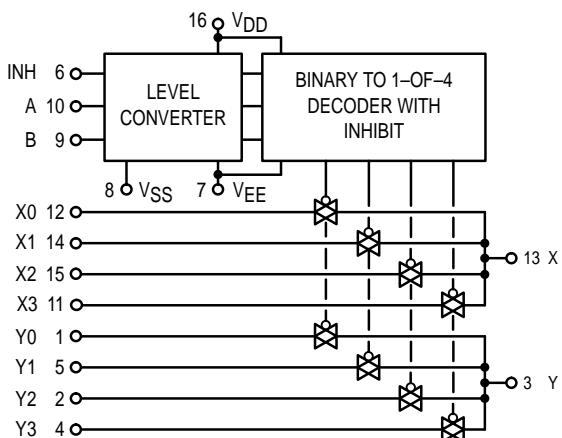


Figure 3. MC14052B Functional Diagram

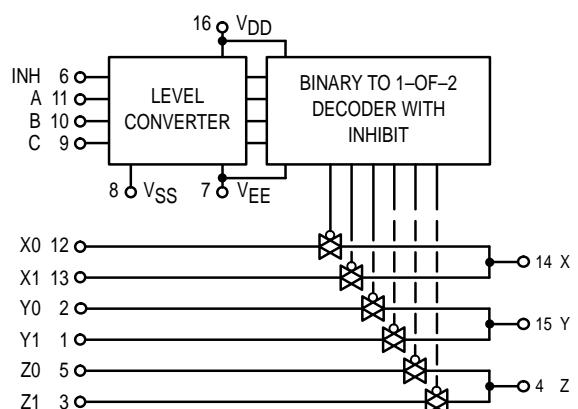
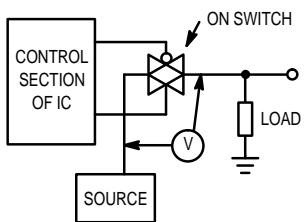
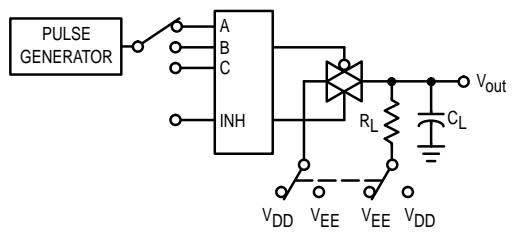


Figure 4. MC14053B Functional Diagram

## TEST CIRCUITS

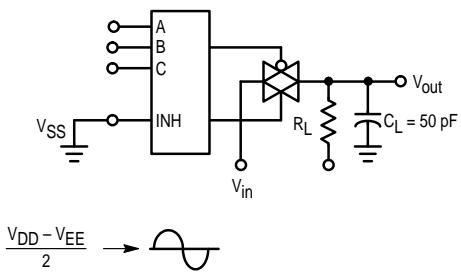


**Figure 5.  $\Delta V$  Across Switch**

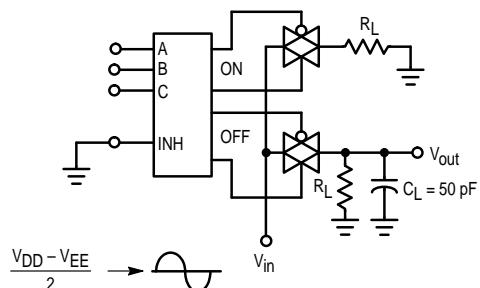


**Figure 6. Propagation Delay Times,  
Control and Inhibit to Output**

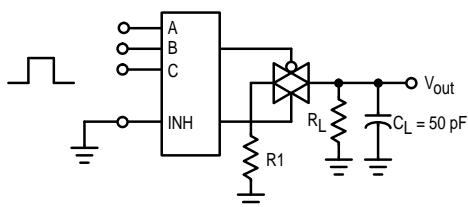
A, B, and C inputs used to turn ON or OFF the switch under test.



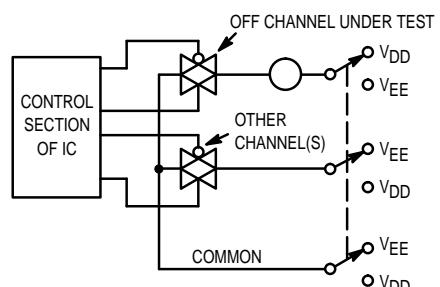
**Figure 7. Bandwidth and Off-Channel Feedthrough Attenuation**



**Figure 8. Channel Separation  
(Adjacent Channels Used For Setup)**

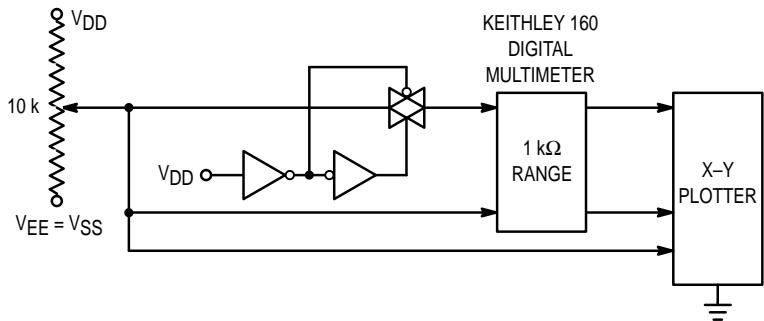


**Figure 9. Crosstalk, Control Input to Common O/I**

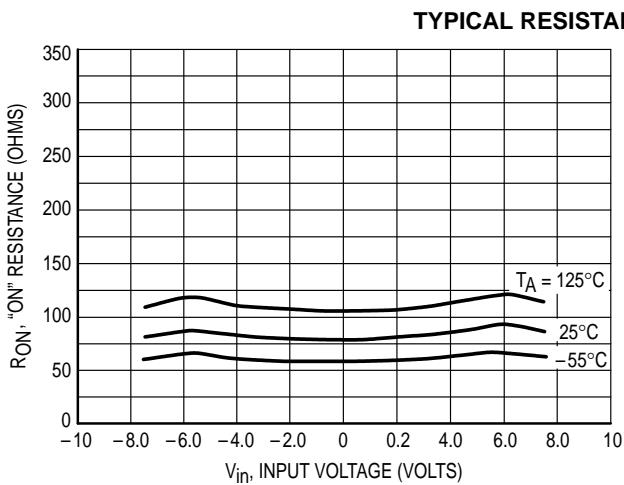


**Figure 10. Off Channel Leakage**

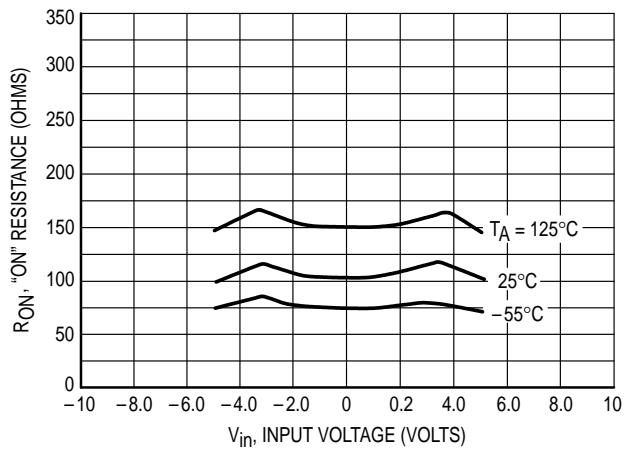
NOTE: See also Figures 7 and 8 on Page 6-51.



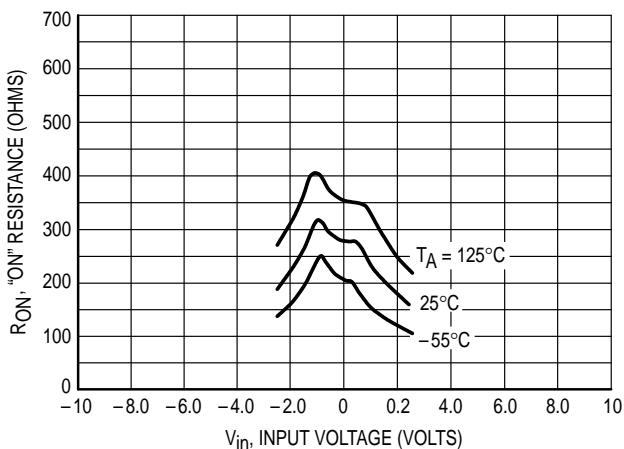
**Figure 11. Channel Resistance ( $R_{ON}$ ) Test Circuit**



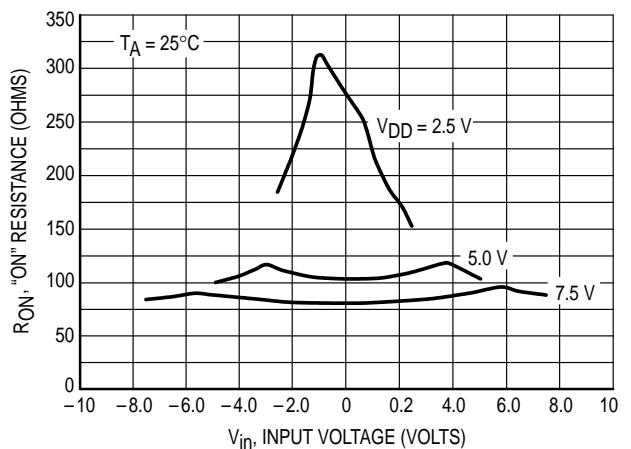
**Figure 12.**  $V_{DD} = 7.5$  V,  $V_{EE} = -7.5$  V



**Figure 13.**  $V_{DD} = 5.0$  V,  $V_{EE} = -5.0$  V



**Figure 14.**  $V_{DD} = 2.5$  V,  $V_{EE} = -2.5$  V



**Figure 15. Comparison at 25°C,  $V_{DD} = -V_{EE}$**

## **PIN ASSIGNMENT**

MC14051B		
X4	1 ●	16
X6	2	15
X	3	14
X7	4	13
X5	5	12
INH	6	11
V <sub>EE</sub>	7	10
V <sub>SS</sub>	8	9

The diagram shows the logic symbol for the MC14052B integrated circuit. It features a central rectangle with two columns of pins. The left column contains pins Y0, Y2, Y, Y3, Y1, INH, V<sub>EE</sub>, and V<sub>SS</sub>. The right column contains pins 16, 15, 14, 13, 12, 11, 10, 9, and V<sub>DD</sub>. The output pins (Y0, Y2, Y, Y3, Y1) are connected to the inputs of a 5-input OR gate. The INH pin is connected to the inhibit input of the OR gate. The output of the OR gate is connected to the 16-pin terminal. The 15-pin terminal is connected to the 14-pin terminal, which is then connected to the 13-pin terminal. The 12-pin terminal is connected to the 11-pin terminal, which is then connected to the 10-pin terminal. The 10-pin terminal is connected to the 9-pin terminal, which is then connected to the V<sub>DD</sub> terminal.

MC14053B		
Y1	1 ●	16
Y0	2	15 Y
Z1	3	14 X
Z	4	13 X1
Z0	5	12 X0
INH	6	11 A
V <sub>EE</sub>	7	10 B
V <sub>SS</sub>	8	9 C

## APPLICATIONS INFORMATION

Figure A illustrates use of the on-chip level converter detailed in Figures 2, 3, and 4. The 0-to-5 V Digital Control signal is used to directly control a 9 V<sub>p-p</sub> analog signal.

The digital control logic levels are determined by  $V_{DD}$  and  $V_{SS}$ . The  $V_{DD}$  voltage is the logic high voltage; the  $V_{SS}$  voltage is logic low. For the example,  $V_{DD} = +5\text{ V}$  = logic high at the control inputs;  $V_{SS} = \text{GND} = 0\text{ V}$  = logic low.

The maximum analog signal level is determined by  $V_{DD}$  and  $V_{EE}$ . The  $V_{DD}$  voltage determines the maximum recommended peak above  $V_{SS}$ . The  $V_{EE}$  voltage determines the maximum swing below  $V_{SS}$ . For the example,  $V_{DD} - V_{SS} = 5\text{ V}$  maximum swing above  $V_{SS}$ ;  $V_{SS} - V_{EE} = 5\text{ V}$  maximum swing below  $V_{SS}$ . The example shows a  $\pm 4.5\text{ V}$  signal which allows a 1/2 volt margin at each peak. If voltage transients

above  $V_{DD}$  and/or below  $V_{EE}$  are anticipated on the analog channels, external diodes ( $D_X$ ) are recommended as shown in Figure B. These diodes should be small signal types able to absorb the maximum anticipated current surges during clipping.

The *absolute* maximum potential difference between  $V_{DD}$  and  $V_{EE}$  is 18.0 V. Most parameters are specified up to 15 V which is the *recommended* maximum difference between  $V_{DD}$  and  $V_{EE}$ .

Balanced supplies are not required. However,  $V_{SS}$  must be greater than or equal to  $V_{EE}$ . For example,  $V_{DD} = +10\text{ V}$ ,  $V_{SS} = +5\text{ V}$ , and  $V_{EE} = -3\text{ V}$  is acceptable. See the Table below.

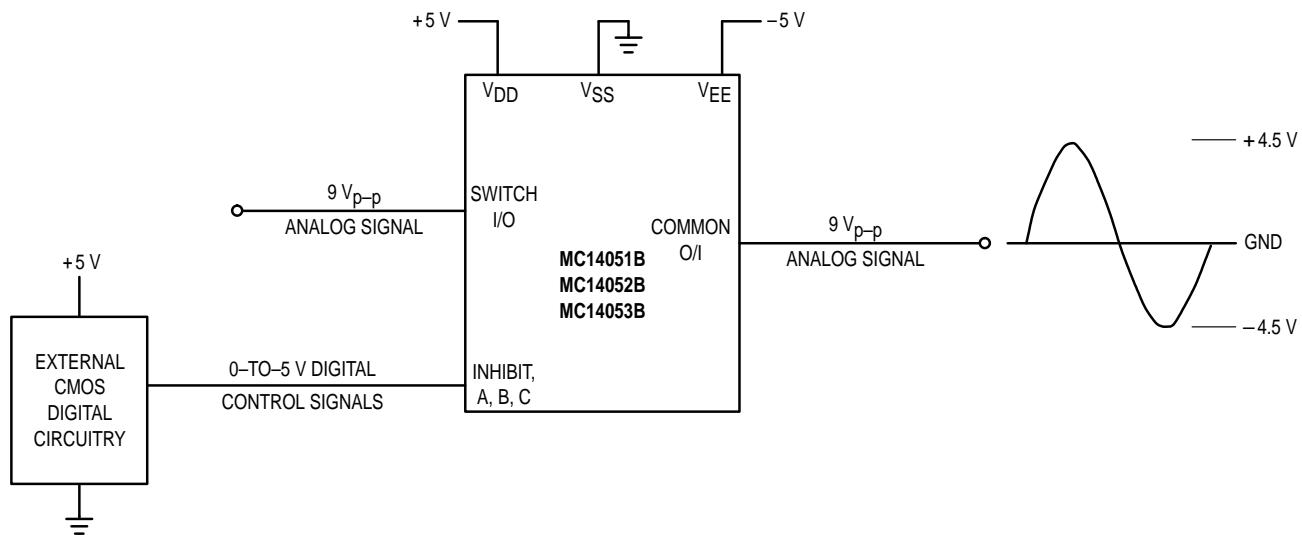


Figure A. Application Example

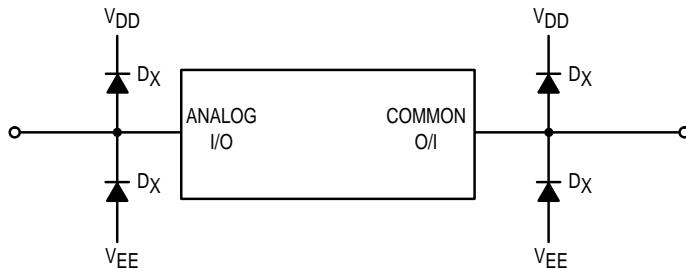


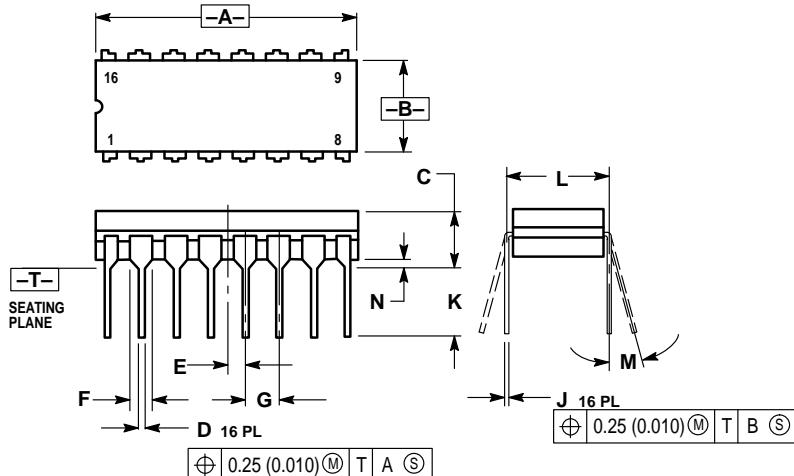
Figure B. External Germanium or Schottky Clipping Diodes

### POSSIBLE SUPPLY CONNECTIONS

$V_{DD}$ In Volts	$V_{SS}$ In Volts	$V_{EE}$ In Volts	Control Inputs Logic High/Logic Low In Volts	Maximum Analog Signal Range In Volts
+ 8	0	- 8	+ 8/0	+ 8 to - 8 = 16 V <sub>p-p</sub>
+ 5	0	- 12	+ 5/0	+ 5 to - 12 = 17 V <sub>p-p</sub>
+ 5	0	0	+ 5/0	+ 5 to 0 = 5 V <sub>p-p</sub>
+ 5	0	- 5	+ 5/0	+ 5 to - 5 = 10 V <sub>p-p</sub>
+ 10	+ 5	- 5	+ 10/ + 5	+ 10 to - 5 = 15 V <sub>p-p</sub>

## OUTLINE DIMENSIONS

**L SUFFIX**  
CERAMIC DIP PACKAGE  
CASE 620-10  
ISSUE V

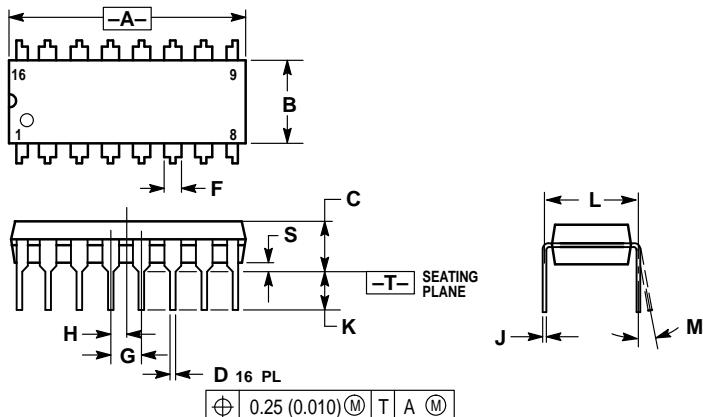


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C		0.200		5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

**P SUFFIX**  
PLASTIC DIP PACKAGE  
CASE 648-08  
ISSUE R

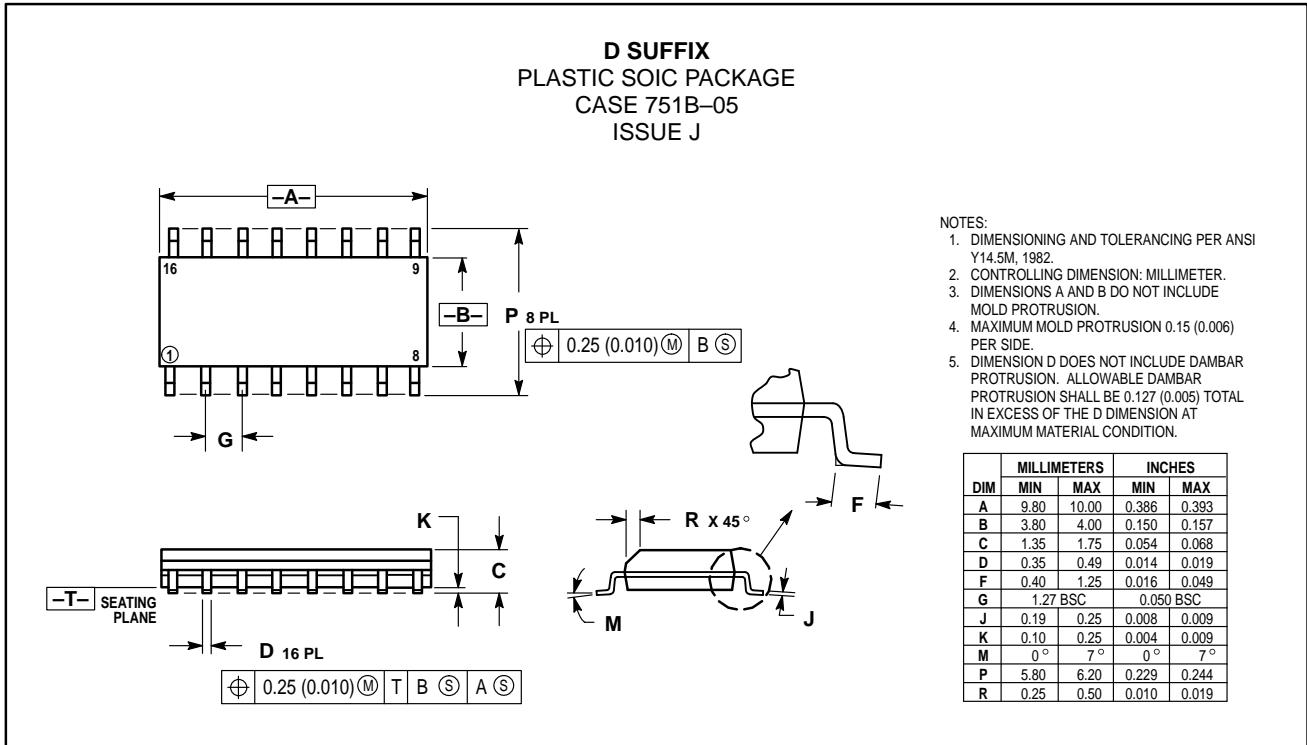


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

## OUTLINE DIMENSIONS



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